

## Chip Inductors for RF Applications (Wire wound-open)

FASTRON wire wound chip inductors are designed particularly for RF applications that require optimal Q on high frequency circuits. Its gold flash pad metallization provides better solderability for a higher yield in your production. In addition, their encapsulation not only protects the winding but also allows surface mount assembly. It comes in compact sizes (from 0402 to 1812) available in reel packing. Inductance values between those listed in this catalog are mostly available on request. Ferrite core versions are also available for selected case sizes for applications which require higher inductances in a smaller case size.

Applications

Used in LC resonant circuits such as oscillator and signal generators, impedance matching, RF filters etc.

Mobile Telecommunication: GSM, CDMA, TCDMA, cordless phones, 2 way radio

Automotive Subsystems: TPMS, Keyless Entry, Anti-Theft, GPS Wireless Communication: W-LAN, WIFI, WIMAX, RFID, Bluetooth

## **Technical Data**

L – Value (rated inductance)	≥ 1 MHz measured with HP 4286A RF LCR meter at frequency f <sub>L</sub> < 1 MHz measured with HP 4194A RF LCR meter at frequency f <sub>L</sub>						
Q – Factor (min)	≥ 1 MHz measured with HP 4287A RF LCR meter at frequency fo < 1 MHz measured with HP 4194A RF LCR meter at frequency fo						
SRF (min)	Measured with HP 8753ES Network Analyzer						
DCR (max)	Measured at 25°C						
Operating Temperature	For ceramic core from -40°C to +150°C (Includes component self-heating) For ferrite core from -40°C to +85°C						
Surface Finishing	Epoxy molded flat top for perfect pick and place assembly						
Pad Metallization	Gold flash as top layer						
Wire Termination	Spot welding						
Recommended soldering method	Reflow						
Moisture Sensitivity Levels (MSL)	MSL Level 1, indicating unlimited floor life at ≤ 30°C / 85% relative humidity						
Solderability	Using lead free solder (Sn 99.9) at 260°C ± 5°C for 5 ± 0.5 seconds, min 90% solder coverage of metallization Standard: IEC 68-2-20 (Ta)						
Resistance to Soldering Heat	Resistant to 260°C ± 5°C for 10 ± 1 seconds Standard: IEC 68-2-20 (Tb)						
Resistance to Solvent	Resistant to Isopropyl alcohol for $5\pm0.5$ minutes at 23°C $\pm$ 5°C Standard: IEC 68-2-45						
Climatic Test	Defined by the following standards IEC 68-2-1 for Cold test: -55°C for 96 hours IEC 68-2-2 for Dry heat test: +85°C for ferrite core and 125°C for ceramic core for 96 hours IEC 60068-2-78 for Humidity test: 40°C at RH 95% for 4 days						
Thermal Shock Test	Temperature cycle (ceramic): -40°C to +125°C to -40°C Temperature cycle (ferrite): -40°C to +85°C to -40°C Max/Min temperature duration: 15 minutes Temperature transition duration: 5 minutes Cycles: 25 Standard: MIL-STD-202G						
Adhesion of Soldered Component (Shear Test)	Components withstand a pushing force of 10N for 10 $\pm$ 1 seconds Standard: IEC 60068-2-21, method Ue <sub>3</sub>						
Mechanical Shock	Mil-Std 202 Method 213, Condition C 3 axis, 6 times, total 18 shocks 100 G, 6 ms, half-sine						
Vibration							

Ordering Code Example: <u>0402AS</u>-1<u>N0X-YY</u> → **0402AS-1N0K-01** 

0402 AS - 1N0 X - YY (Case Size) (Core Type) - (Inductance Value) (Tolerance) (Packing Code)

Case Sizes - 0402, 0603, 0805, 1008, 1206, 1210, 1812

Core Type - AS, AQ (Ceramic), F (Ferrite), AF (Ceramic & Ferrite)
Tolerances - F (1%), G (2%), A (3%), J (5%), K (10%), M (20%)

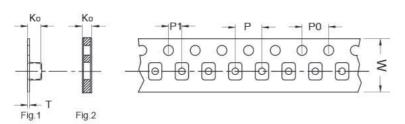
Packing Code - 01, 04, 08 (Reel)

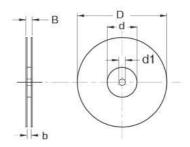
Revision date: 04 Sept 2013



## **Chip Inductors for RF Applications (Wire wound-open)**

## Packing Specification





drawing only schematic, see table

Type	Packing Code	D	d	d1	В	b	W	Р	P0	P1	K <sub>o</sub>	T	Fig
)402	01, 08	180	60	13	12.7	8.4	8	2	4	2	0.6	æ	2
0603	01, 08	180	60	13	12.7	8.4	8	4	4	2	1.0	0.25	1
0603	04	330	100	13	14.4	8.4	8	4	4	2	1.0	0.25	1
0805	01	180	60	13	12.7	8.4	8	4	4	2	1.63	0.25	1
0805	04	330	100	13	14.4	8.4	8	4	4	2	1.63	0.25	1
1008	01	180	60	13	12.7	8.4	8	4	4	2	2.23	0.3	1
1008	04	330	100	13	14.4	8.4	8	4	4	2	1.63	0.25	1
1206	01	180	60	13	12.7	8.4	8	4	4	2	1.8	0.2	1
1206	04	330	100	13	14.4	8.4	8	4	4	2	1.8	0.2	1
1210	01	180	60	13	18.4	13.7	12	8	4	2	2.55	0.3	1
1210	04	330	100	13	18.4	12.4	12	8	4	2	2.55	0.3	1
1812	01	180	60	13	18.4	13.7	12	8	4	2	3.70	0.35	1
1812	04	330	100	13	18.4	12.4	12	8	4	2	3.70	0.35	1